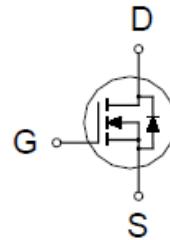
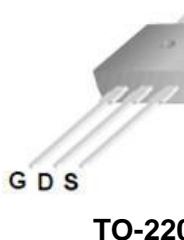


P057AAT

N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
75V	5.8m Ω @ $V_{GS} = 10V$	129A



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	LIMITS	UNITS
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ¹	I_D	129	A
$T_C = 100^\circ C$	I_D	82	
Pulsed Drain Current ²	I_{DM}	410	
Avalanche Current	I_{AS}	60	
Avalanche Energy	E_{AS}	557	mJ
Power Dissipation	P_D	192	W
$T_C = 100^\circ C$	P_D	77	
Operating Junction & Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ C$
Lead Temperature ('/16" from case for 10 sec.)	T_L	275	

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$	0.65	63	$^\circ C / W$
Junction-to-Ambient	$R_{\theta JA}$			

¹Limited by package.

²Pulse width limited by maximum junction temperature.

P057AAT

N-Channel Enhancement Mode MOSFET

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	75			V
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	2.0	2.5	4.0	
Gate-Body Leakage	I_{GSS}	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 20\text{V}$			± 250	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 60\text{V}, V_{\text{GS}} = 0\text{V}$			1	μA
		$V_{\text{DS}} = 60\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 125^\circ\text{C}$			10	
On-State Drain Current ¹	$I_{\text{D}(\text{ON})}$	$V_{\text{DS}} = 10\text{V}, V_{\text{GS}} = 10\text{V}$	129			A
Drain-Source On-State Resistance ¹	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}} = 10\text{V}, I_D = 100\text{A}$		4.7	5.8	$\text{m}\Omega$
Forward Transconductance ¹	g_{fs}	$V_{\text{DS}} = 25\text{V}, I_D = 50\text{A}$			100	S
DYNAMIC						
Input Capacitance	C_{iss}	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 25\text{V}, f = 1\text{MHz}$		12500		pF
Output Capacitance	C_{oss}			1090		
Reverse Transfer Capacitance	C_{rss}			629		
Gate Resistance	R_g	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 0\text{V}, f = 1\text{MHz}$		3.8	4	Ω
Total Gate Charge ²	Q_g	$V_{\text{DS}} = 60\text{V}, V_{\text{GS}} = 10\text{V}, I_D = 80\text{A}$		223		nC
Gate-Source Charge ²	Q_{gs}			64		
Gate-Drain Charge ²	Q_{gd}			80		
Turn-On Delay Time ²	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 40\text{V}, I_D \approx 40\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GS}} = 2.5\Omega$		40		nS
Rise Time ²	t_r			60		
Turn-Off Delay Time ²	$t_{\text{d}(\text{off})}$			130		
Fall Time ²	t_f			50		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ\text{C}$)						
Continuous Current ³	I_S				129	A
Forward Voltage ¹	V_{SD}	$I_F = 100\text{A}, V_{\text{GS}} = 0\text{V}$			1.3	V
Reverse Recovery Time	t_{rr}				90	nS
Reverse Recovery Charge	Q_{rr}				260	nC

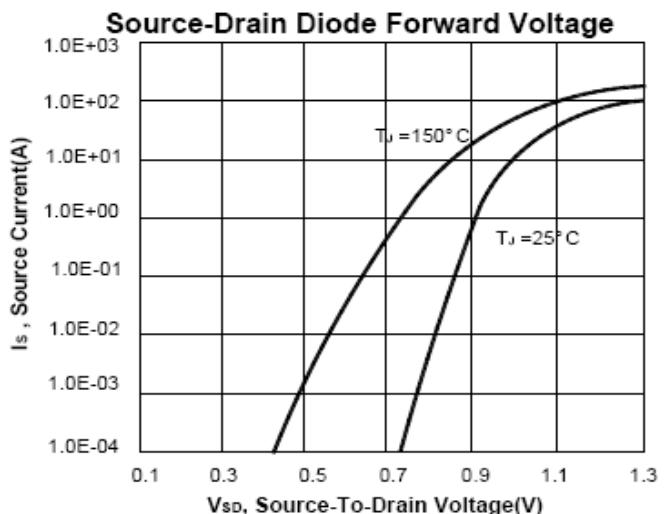
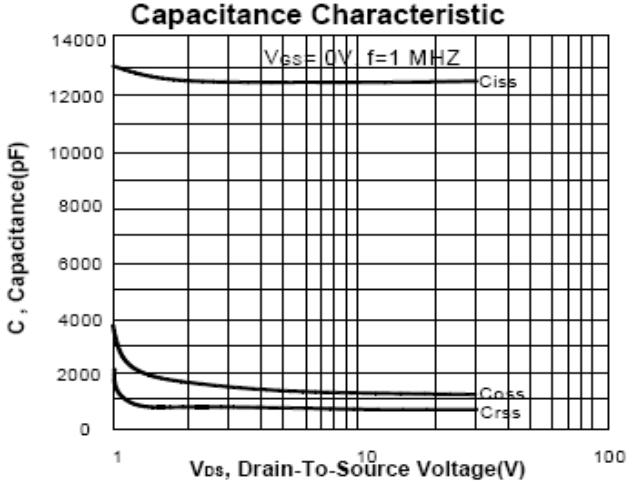
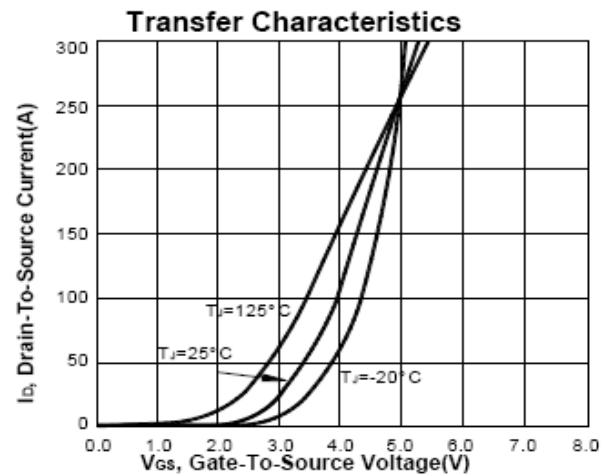
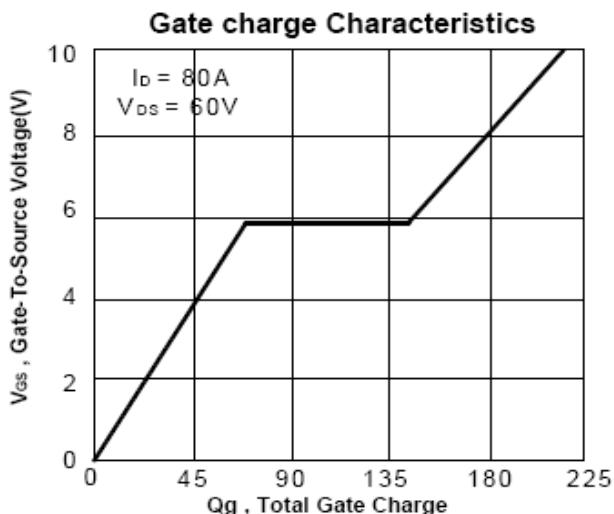
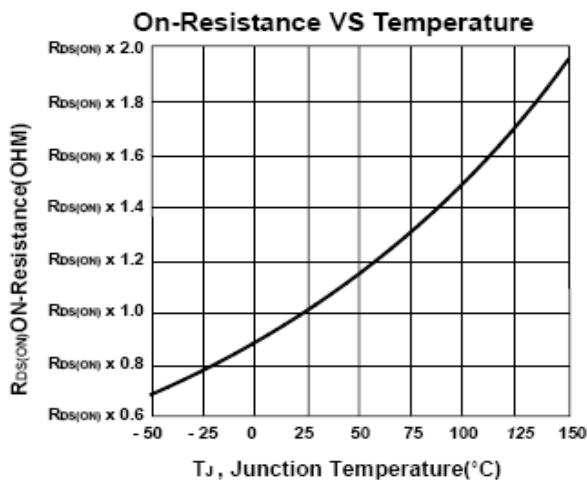
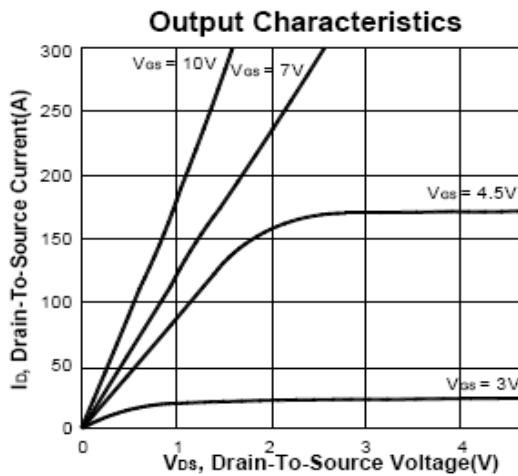
¹Pulse test : Pulse Width $\leq 300\ \mu\text{sec}$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

³Limited by package.

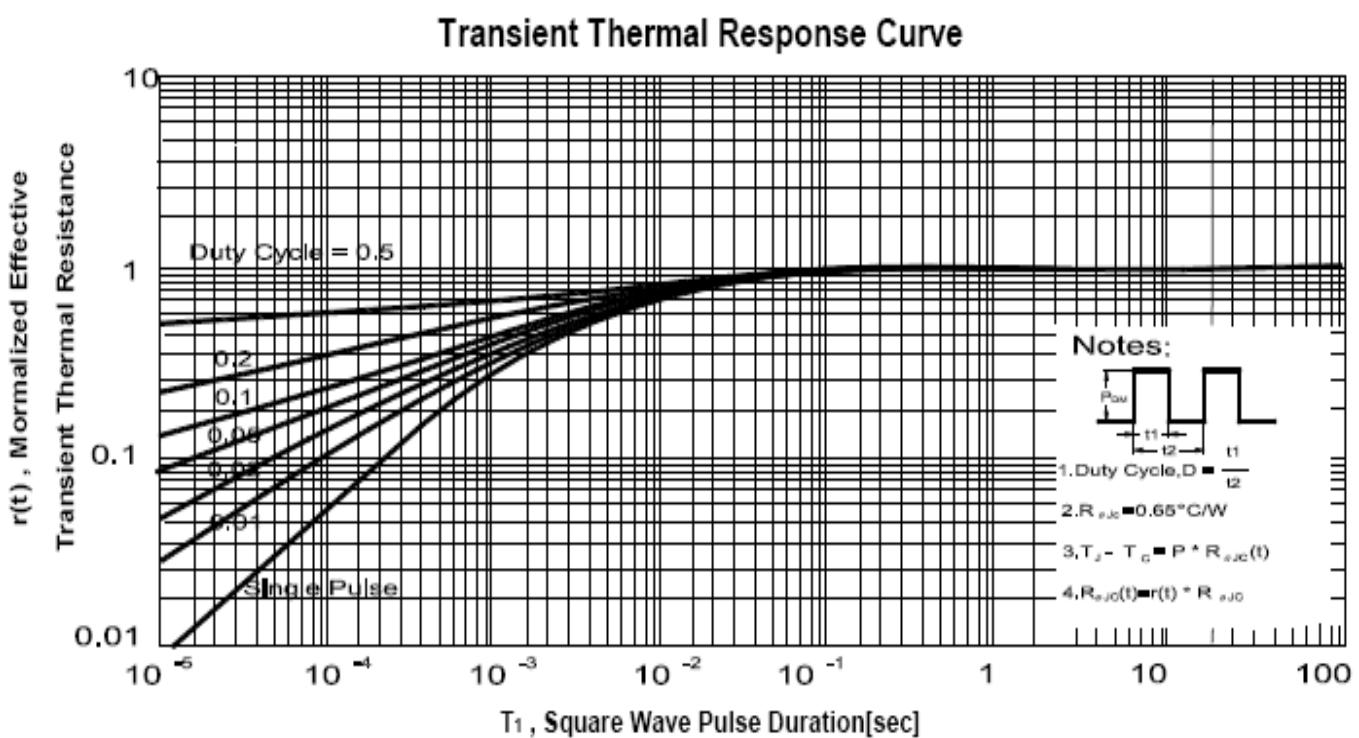
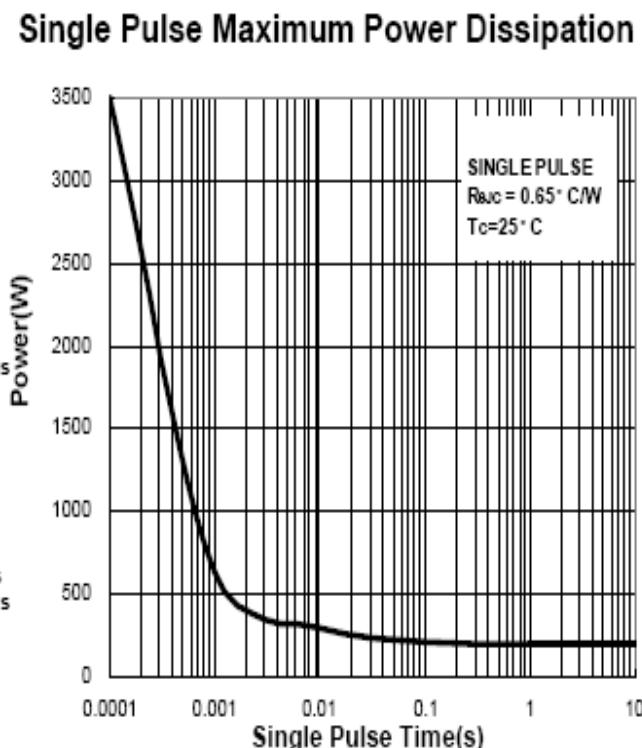
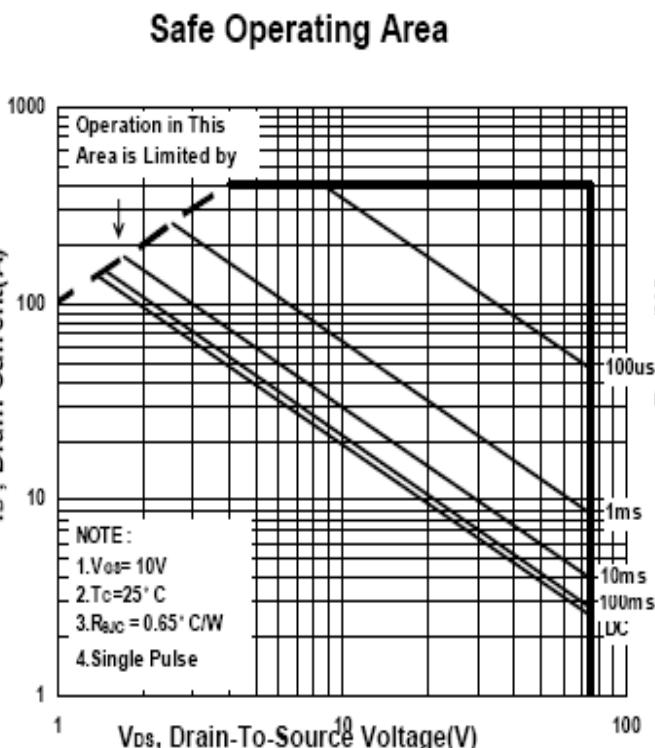
P057AAT

N-Channel Enhancement Mode MOSFET



P057AAT

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P057AAT

N-Channel Enhancement Mode MOSFET

Package Dimension

TO-220 (3-Lead) MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	9.652	10.16	11.5	H	2.04	2.54	3.04
B	2.54	2.79	3.048	I	1.15	1.52	1.778
C	17.3		22.86	J	3.556	4.57	4.826
D	26.924	29.03	31.242	K	0.508	1.3	1.45
E	14.224	15.45	16.510	L	1.89	2.69	3.09
F	8.382	9.20	9.40	M	0.34	0.5	0.6
G	0.381	0.81	1.016	N			

